

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEN-YI HSIEH	06/05/2009
SHIH-WEI HSIAO	06/05/2009
RECEIVING PARTY DATA	
Name:	HON HAI PRECISION INDUSTRY CO., LTD.
Street Address:	No. 2, Tzu Yu Street
City:	Tu-Cheng, Taipei Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12485066
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NAME OF SUBMITTER:	WEI TE CHUNG
Total Attachments: 2 source=US20178090608ASM#page1.tif source=US20178090608ASM#page2.tif	

CH \$40.00 12485066

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PATENT
REEL: 022828 FRAME: 0771

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. Wen-Yi Hsieh, residing at Tu-Cheng, Taiwan
2. Shih-Wei Hsiao, residing at Tu-Cheng, Taiwan
3. _____, residing at _____
4. _____, residing at _____
5. _____, residing at _____
6. _____, residing at _____
7. _____, residing at _____
8. _____, residing at _____

hereby sell(s), assign(s) and transfer(s) unto: HON HAI PRECISION IND. CO., LTD. having a principal place of business at No. 2, Tzu Yu Street, Tu-Chen City, Taipei Hsien, Taiwan hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as ELECTRICAL CONTACT WITH OVERLAPPING STRUCTURE for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Wen-Yi Hsieh</u> Wen-Yi Hsieh, inventor	<u>06/05/09</u> Date	<u> </u> Witness
2.	<u>Shih-Wei Hsiao</u> Shih-Wei Hsiao, inventor	<u>06/05/09</u> Date	<u> </u> Witness
3.	<u> </u> inventor	<u> </u> Date	<u> </u> Witness
4.	<u> </u> inventor	<u> </u> Date	<u> </u> Witness
5.	<u> </u> inventor	<u> </u> Date	<u> </u> Witness
6.	<u> </u> inventor	<u> </u> Date	<u> </u> Witness
7.	<u> </u> inventor	<u> </u> Date	<u> </u> Witness
8.	<u> </u> inventor	<u> </u> Date	<u> </u> Witness